74LVC1G79

Single D-type flip-flop; positive-edge trigger Rev. 11 — 2 July 2012

Product data sheet

1. **General description**

The 74LVC1G79 provides a single positive-edge triggered D-type flip-flop.

Information on the data input is transferred to the Q-output on the LOW-to-HIGH transition of the clock pulse. The D-input must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of this device in a mixed 3.3 V and 5 V environment.

This device is fully specified for partial power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

Features and benefits 2.

- Wide supply voltage range from 1.65 V to 5.5 V
- High noise immunity
- Complies with JEDEC standard:
 - ◆ JESD8-7 (1.65 V to 1.95 V)
 - ◆ JESD8-5 (2.3 V to 2.7 V)
 - ◆ JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- \pm 24 mA output drive (V_{CC} = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.



Single D-type flip-flop; positive-edge trigger

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | | | | | |
|-------------|-------------------|--------|--|----------|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | |
| 74LVC1G79GW | –40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package; 5 leads; body width 1.25 mm | SOT353-1 | | | | |
| 74LVC1G79GV | –40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads | SOT753 | | | | |
| 74LVC1G79GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1.45 \times 0.5$ mm | SOT886 | | | | |
| 74LVC1G79GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body $1 \times 1 \times 0.5$ mm | SOT891 | | | | |
| 74LVC1G79GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm | SOT1115 | | | | |
| 74LVC1G79GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm | SOT1202 | | | | |
| 74LVC1G79GX | –40 °C to +125 °C | X2SON5 | X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body $0.8\times0.8\times0.35$ mm | SOT1226 | | | | |

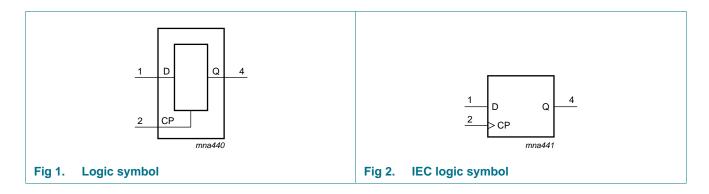
4. Marking

Table 2. Marking codes

| Type number | Marking ^[1] |
|-------------|------------------------|
| 74LVC1G79GW | VP |
| 74LVC1G79GV | V79 |
| 74LVC1G79GM | VP |
| 74LVC1G79GF | VP |
| 74LVC1G79GN | VP |
| 74LVC1G79GS | VP |
| 74LVC1G79GX | VP |

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

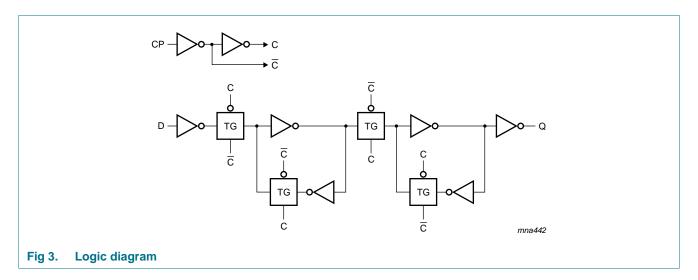
5. Functional diagram



74LVC1G79

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Single D-type flip-flop; positive-edge trigger



6. Pinning information

6.1 Pinning





Single D-type flip-flop; positive-edge trigger

6.2 Pin description

Table 3. Pin description

| Symbol | Pin | Pin | | |
|----------|-------------------|-------|-------------------|--|
| | TSSOP5 and X2SON5 | XSON6 | _ | |
| D | 1 | 1 | data input | |
| CP | 2 | 2 | clock pulse input | |
| GND | 3 | 3 | ground (0 V) | |
| Q | 4 | 4 | data output | |
| n.c. | - | 5 | not connected | |
| V_{CC} | 5 | 6 | supply voltage | |

7. Functional description

Table 4. Function table[1]

| • | | Output |
|------------|---|--------|
| СР | D | Q |
| \uparrow | L | L |
| \uparrow | Н | Н |
| L | X | q |

^[1] H = HIGH voltage level;

L = LOW voltage level;

 $[\]uparrow$ = LOW-to-HIGH CP transition;

X = don't care;

q = lower case letter indicates the state of referenced input, one set-up time prior to the LOW-to-HIGH CP transition.

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|------------------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| VI | input voltage | | [<u>1]</u> -0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V | - | ±50 | mA |
| Vo | output voltage | Active mode | [1][2] -0.5 | $V_{CC} + 0.5$ | V |
| | | Power-down mode | [1][2] -0.5 | +6.5 | V |
| Io | output current | $V_O = 0 V \text{ to } V_{CC}$ | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$ | [3] _ | 250 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-------------------------------------|---|------|-----|----------|------|
| V_{CC} | supply voltage | | 1.65 | - | 5.5 | V |
| V_{I} | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | Active mode | 0 | - | V_{CC} | V |
| | | V _{CC} = 0 V; Power-down mode | 0 | - | 5.5 | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$ | - | - | 20 | ns/V |
| | | $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$ | - | - | 10 | ns/V |

^[2] When $V_{CC} = 0 \text{ V}$ (Power-down mode), the output voltage can be 5.5 V in normal operation.

^[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 and X2SON5 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

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10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbo | l Parameter | Conditions | Min | Typ[1] | Max | Unit |
|--------------------|---------------------------|---|----------------------|--------|--------------------------|--------------|
| T _{amb} = | –40 °C to +85 °C | | | | | |
| V _{IH} | HIGH-level input voltage | V _{CC} = 1.65 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | V |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.7 | - | - | V |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2.0 | - | - | V |
| | | V _{CC} = 4.5 V to 5.5 V | $0.7 \times V_{CC}$ | - | - | V |
| V_{IL} | LOW-level input voltage | V _{CC} = 1.65 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | V |
| | | V _{CC} = 4.5 V to 5.5 V | - | - | $0.3 \times V_{CC}$ | V |
| V _{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_{O} = -100 \ \mu A; \ V_{CC} = 1.65 \ V \ to \ 5.5 \ V$ | $V_{CC}-0.1$ | - | - | V |
| | | $I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | V |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.3 | - | - | V |
| | | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.8 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 100 \mu A$; $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}$ | - | - | 0.1 | V |
| | | $I_{O} = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.45 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.3 | V |
| | | $I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.4 | V |
| | | $I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | V |
| | | $I_O = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | - | 0.55 | V |
| I _I | input leakage current | $V_I = 5.5 \text{ V or GND}$; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$ | - | ±0.1 | ±5 | μΑ |
| I _{OFF} | power-off leakage current | $V_{CC} = 0 \text{ V}$; $V_{I} \text{ or } V_{O} = 5.5 \text{ V}$ | - | ±0.1 | ±10 | μΑ |
| I _{CC} | supply current | $V_I = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V}; I_O = 0 \text{ A}$ | - | 0.1 | 10 | μΑ |
| Δl _{CC} | additional supply current | per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$ | - | 5 | 500 | μА |
| Cı | input capacitance | $V_{CC} = 3.3 \text{ V}; V_I = \text{GND to } V_{CC}$ | - | 5 | - | pF |
| T _{amb} = | –40 °C to +125 °C | | | | | |
| V_{IH} | HIGH-level input voltage | V _{CC} = 1.65 V to 1.95 V | $0.65 \times V_{CC}$ | - | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.7 | - | - | V |
| | | V _{CC} = 2.7 V to 3.6 V | 2.0 | - | - | V |
| | | V _{CC} = 4.5 V to 5.5 V | $0.7 \times V_{CC}$ | - | - | V |
| V _{IL} | LOW-level input voltage | V _{CC} = 1.65 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | V _{CC} = 2.7 V to 3.6 V | - | - | 0.8 | V |
| | | V _{CC} = 4.5 V to 5.5 V | - | - | $0.3 \times V_{CC}$ | V |
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| | data about | Boy 11 3 July 2012 | | | , | 6 05 2 |

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Table 7. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|------------------|---------------------------|---|--------------|--------|------|------|
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -100~\mu A;~V_{CC} = 1.65~V$ to 5.5 V | $V_{CC}-0.1$ | - | - | V |
| | | $I_O = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 0.95 | - | - | V |
| | | $I_O = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.7 | - | - | V |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 1.9 | - | - | V |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.0 | - | - | V |
| | | $I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | 3.4 | - | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | I_{O} = 100 μ A; V_{CC} = 1.65 V to 5.5 V | - | - | 0.1 | V |
| | | $I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | - | - | 0.70 | V |
| | | $I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | - | - | 0.45 | V |
| | | $I_{O} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | - | 0.60 | V |
| | | $I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.80 | V |
| | | $I_O = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$ | - | - | 0.80 | V |
| I _I | input leakage current | $V_I = 5.5 \text{ V or GND}$; $V_{CC} = 0 \text{ V to } 5.5 \text{ V}$ | - | - | ±100 | μΑ |
| I _{OFF} | power-off leakage current | $V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$ | - | - | ±200 | μΑ |
| I _{CC} | supply current | $V_I = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to 5.5 V}; I_O = 0 \text{ A}$ | - | - | 200 | μΑ |
| Δl _{CC} | additional supply current | per pin; $V_{CC} = 2.3 \text{ V to } 5.5 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V};$ $I_{O} = 0 \text{ A}$ | - | - | 5000 | μΑ |

^[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

| Symbol Parameter | | Conditions | -40 | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|------------------|-------------------|--|-----|------------------|-----|-------------------|------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| t _{pd} | propagation delay | CP to Q; see Figure 8 [2] | | | | | | |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 1.0 | 3.6 | 9.9 | 1.0 | 12.5 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 0.5 | 2.3 | 7.0 | 0.5 | 9.0 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 0.5 | 2.6 | 6.0 | 0.5 | 8.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 0.5 | 2.2 | 5.0 | 0.5 | 6.5 | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 0.5 | 1.7 | 3.8 | 0.5 | 5.0 | ns |
| t _{su} | set-up time | D to CP; see Figure 9 | | | | | | |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 2.5 | 1.4 | - | 2.5 | - | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.7 | 0.9 | - | 1.7 | - | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 1.7 | 0.9 | - | 1.7 | - | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.3 | 0.6 | - | 1.2 | - | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 1.2 | 0.6 | - | 1.2 | - | ns |

Single D-type flip-flop; positive-edge trigger

 Table 8.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

| Symbol | Parameter | Conditions | -4 | 10 °C to +85 | 5 °C | -40 °C to | o +125 °C | Unit |
|------------------|-------------------------------|---|-------|--------------|------|-----------|-----------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| t _h | hold time | D to CP; see Figure 9 | ' | ' | • | ' | | |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 0 | -0.7 | - | 0 | - | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 0 | -0.4 | - | 0 | - | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | +0.5 | -0.3 | - | 0.5 | - | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | +0.5 | -0.3 | - | 0.5 | - | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | +0.5 | -0.2 | - | 0.5 | - | ns |
| t _W | pulse width | CP HIGH or LOW; see Figure 9 | | | | | | |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 3.0 | 1.1 | - | 3.0 | - | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 2.5 | 0.7 | - | 2.5 | - | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 2.5 | 0.6 | - | 2.5 | - | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 2.5 | 0.6 | - | 2.5 | - | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 2.0 | 0.5 | - | 2.0 | - | ns |
| f _{max} | maximum | CP; see Figure 9 | | | | | | |
| | frequency | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 160 | 250 | - | 160 | - | MHz |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 160 | 300 | - | 160 | - | MHz |
| | | $V_{CC} = 2.7 \text{ V}$ | 160 | 350 | - | 160 | - | MHz |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 160 | 450 | - | 160 | - | MHz |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 200 | 500 | - | 200 | - | MHz |
| C_{PD} | power dissipation capacitance | $V_I = GND \text{ to } V_{CC};$ $V_{CC} = 3.3 \text{ V}$ | [3] _ | 17 | - | - | - | pF |

^[1] Typical values are measured at $T_{amb} = 25$ °C and $V_{CC} = 1.8$ V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_1 = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

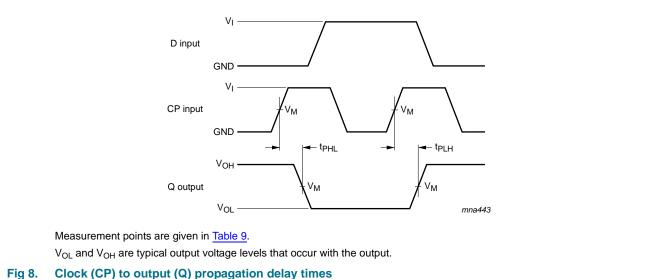
^[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

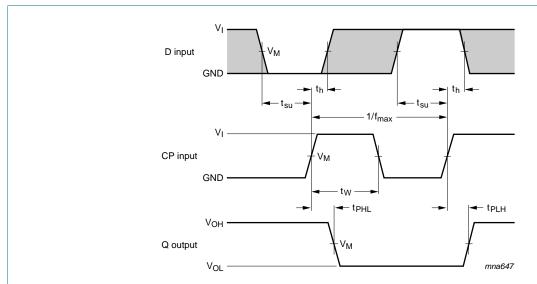
^[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

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12. Waveforms





Measurement points are given in Table 9.

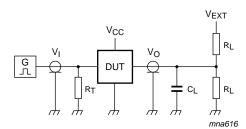
 V_{OL} and V_{OH} are typical output voltage levels that occur with the output.

Clock (CP) to output (Q) propagation delay times, clock pulse width, D to set-up times, the CP to D hold Fig 9. times and maximum clock pulse frequency

Single D-type flip-flop; positive-edge trigger

Table 9. Measurement points

| Supply voltage | Input | Output |
|------------------|---------------------|-----------------------|
| V _{CC} | V _M | V _M |
| 1.65 V to 1.95 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 2.3 V to 2.7 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 2.7 V | 1.5 V | 1.5 V |
| 3.0 V to 3.6 V | 1.5 V | 1.5 V |
| 4.5 V to 5.5 V | $0.5 \times V_{CC}$ | 0.5 × V _{CC} |



Test data is given in Table 10.

Definitions for test circuit:

 R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

Table 10. Test data

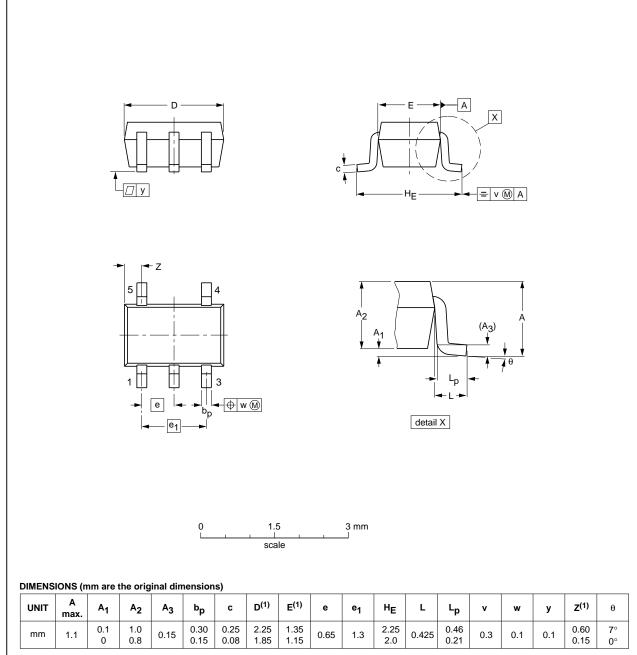
| Supply voltage | Input | | Load | | V _{EXT} |
|------------------|-----------------|-------------|-------|----------------|-------------------------------------|
| V _{CC} | VI | $t_r = t_f$ | CL | R _L | t _{PLH} , t _{PHL} |
| 1.65 V to 1.95 V | V _{CC} | ≤ 2.0 ns | 30 pF | 1 kΩ | open |
| 2.3 V to 2.7 V | V _{CC} | ≤ 2.0 ns | 30 pF | 500 Ω | open |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open |
| 4.5 V to 5.5 V | V _{CC} | ≤ 2.5 ns | 50 pF | 500 Ω | open |

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13. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



Note

^{1.} Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN | ISSUE DATE |
|--------------------|------------|--------|--------|--|------------|----------------------------------|
| | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT353-1 | | MO-203 | SC-88A | | | -00-09-01 03-02-19 |

Fig 11. Package outline SOT353-1 (TSSOP5)

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Single D-type flip-flop; positive-edge trigger

Plastic surface-mounted package; 5 leads

SOT753

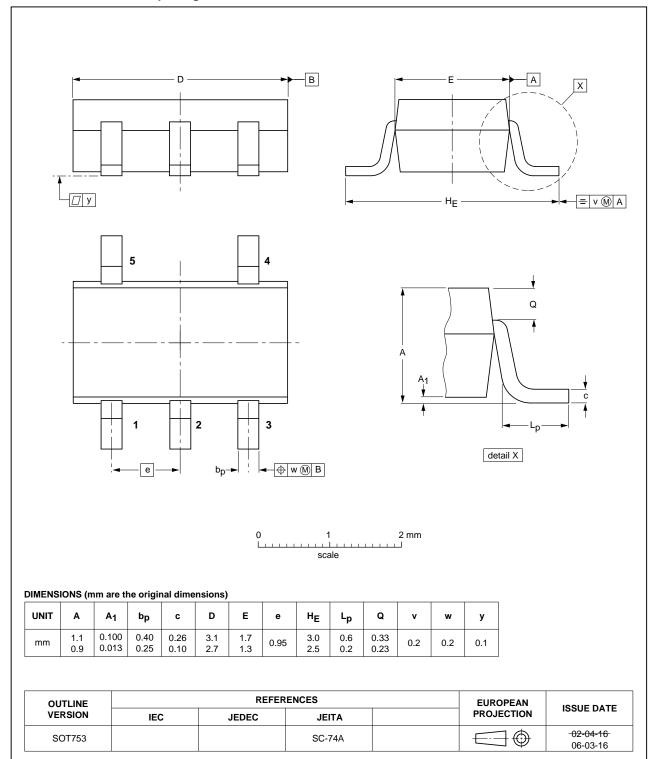


Fig 12. Package outline SOT753 (SC-74A)

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Single D-type flip-flop; positive-edge trigger

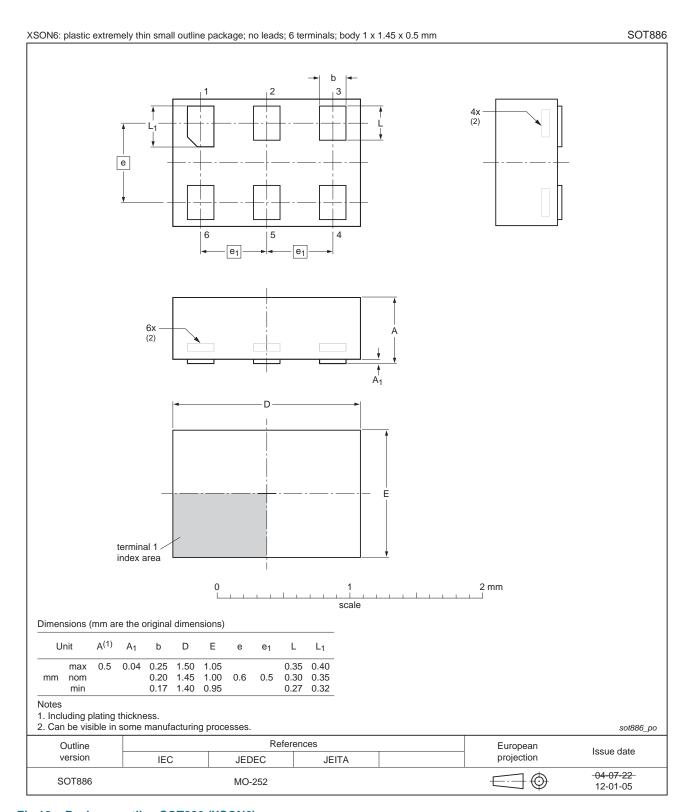


Fig 13. Package outline SOT886 (XSON6)

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Single D-type flip-flop; positive-edge trigger

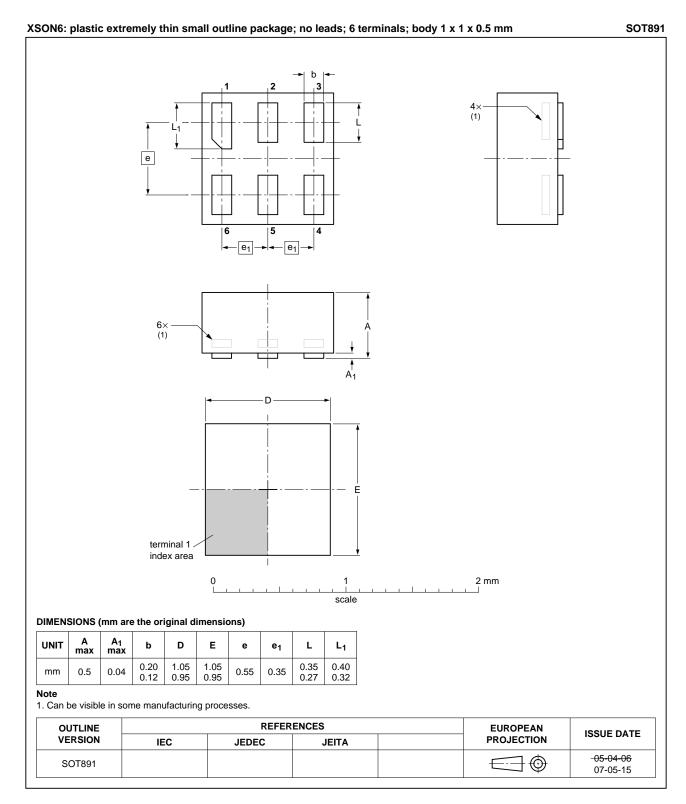


Fig 14. Package outline SOT891 (XSON6)

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Single D-type flip-flop; positive-edge trigger

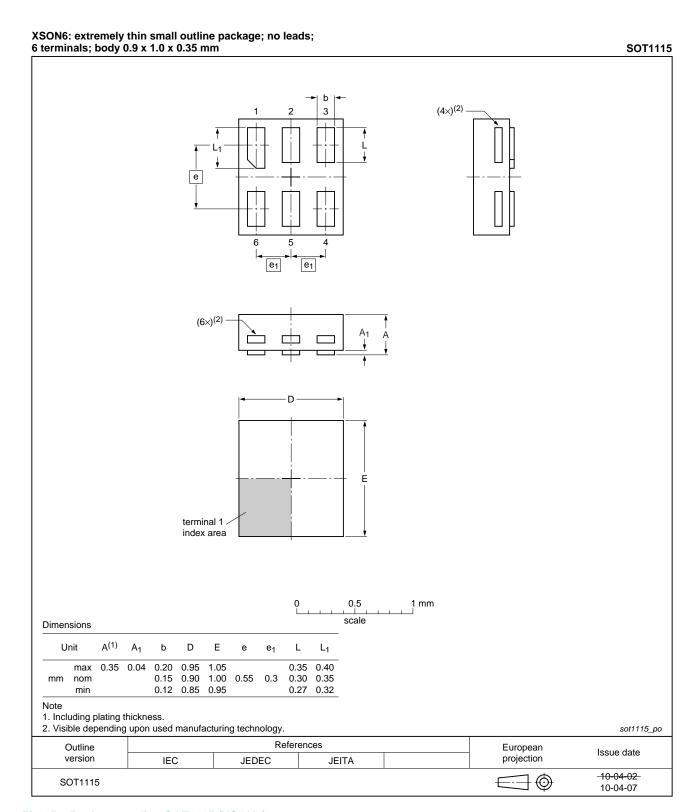


Fig 15. Package outline SOT1115 (XSON6)

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Single D-type flip-flop; positive-edge trigger

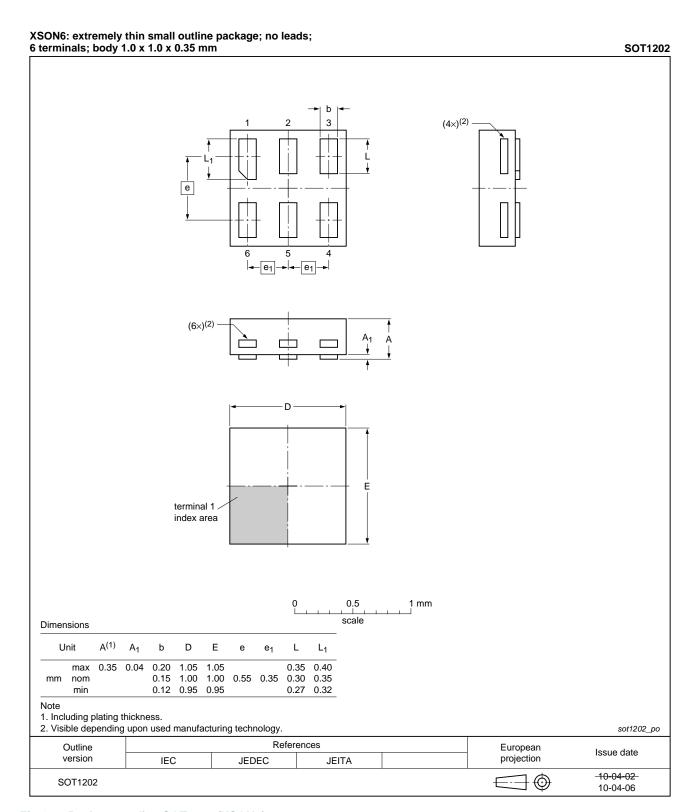


Fig 16. Package outline SOT1202 (XSON6)

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Single D-type flip-flop; positive-edge trigger

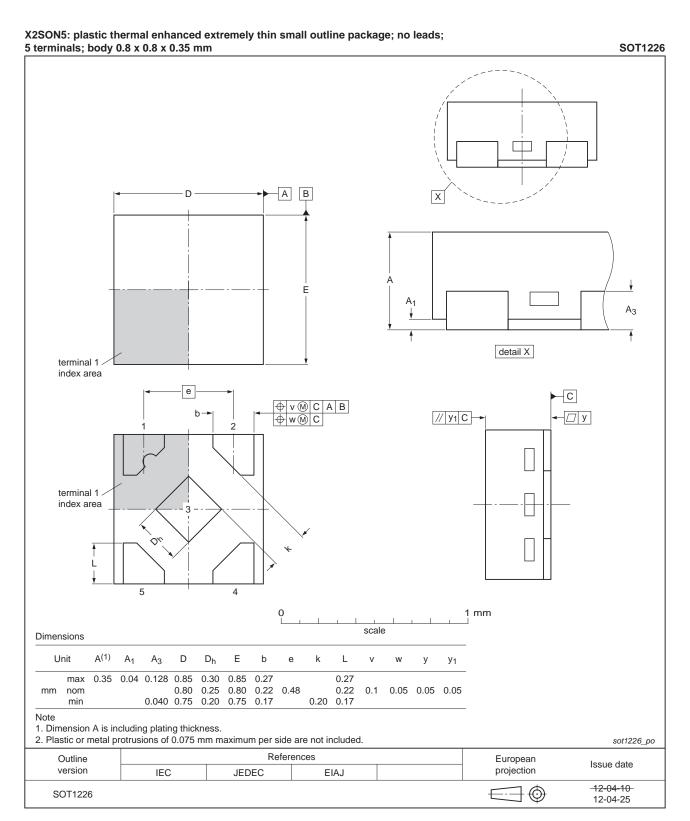


Fig 17. Package outline SOT1226 (X2SON5)

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Single D-type flip-flop; positive-edge trigger

14. Abbreviations

Table 11. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

15. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|-----------------------------------|------------------------------|---------------|----------------|
| 74LVC1G79 v.11 | 20120702 | Product data sheet | - | 74LVC1G79 v.10 |
| Modifications: | Added type | number 74LVC1G79GX (Se | OT1226) | |
| 74LVC1G79 v.10 | 20120402 | Product data sheet | - | 74LVC1G79 v.9 |
| Modifications: | Errata in tal | oel 3 corrected (description | CP input). | |
| 74LVC1G79 v.9 | 20111202 | Product data sheet | - | 74LVC1G79 v.8 |
| Modifications: | Legal pages | s updated. | | |
| 74LVC1G79 v.8 | 20100930 | Product data sheet | - | 74LVC1G79 v.7 |
| 74LVC1G79 v.7 | 20070829 | Product data sheet | - | 74LVC1G79 v.6 |
| 74LVC1G79 v.6 | 20061009 | Product data sheet | - | 74LVC1G79 v.5 |
| 74LVC1G79 v.5 | 20040910 | Product specification | - | 74LVC1G79 v.4 |
| 74LVC1G79 v.4 | 20040317 | Product specification | - | 74LVC1G79 v.3 |
| 74LVC1G79 v.3 | 20030516 | Product specification | - | 74LVC1G79 v.2 |
| 74LVC1G79 v.2 | 20030130 | Product specification | - | 74LVC1G79 v.1 |
| 74LVC1G79 v.1 | 20010404 | Product specification | - | - |
| | | | | |

Single D-type flip-flop; positive-edge trigger

16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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